

P-Channel 12 V (D-S) MOSFET

DESCRIPTION

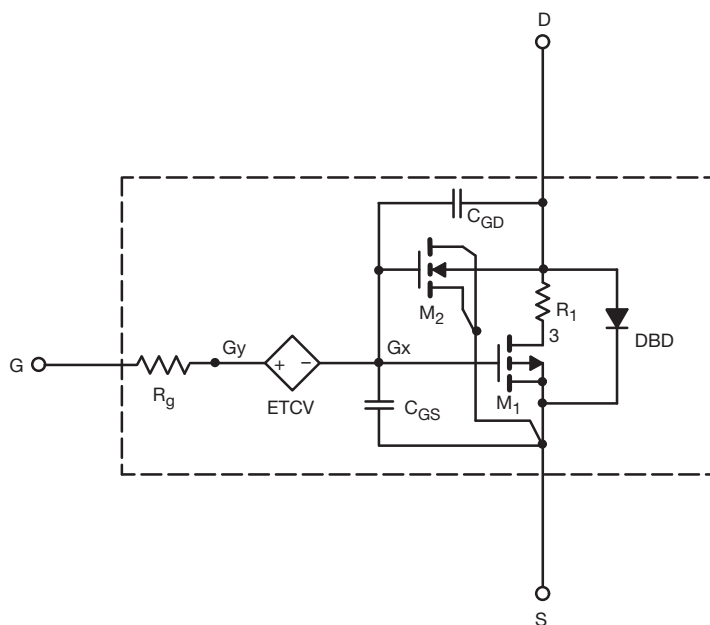
The attached SPICE model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 °C to 125 °C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

CHARACTERISTICS

- P-channel vertical DMOS
- Macro model (subcircuit model)
- Level 3 MOS
- Apply for both linear and switching application
- Accurate over the -55 °C to 125 °C temperature range
- Model the gate charge

SUBCIRCUIT MODEL SCHEMATIC



Note

- This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits



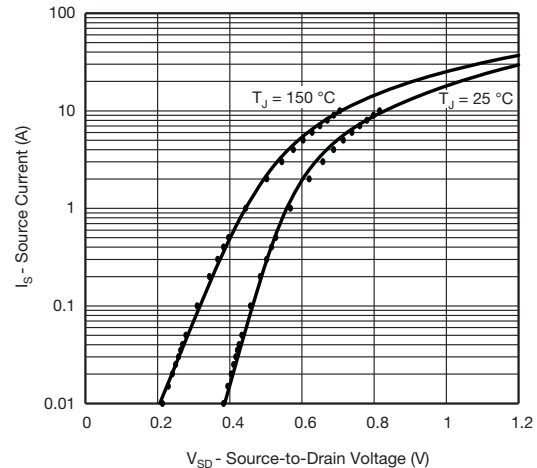
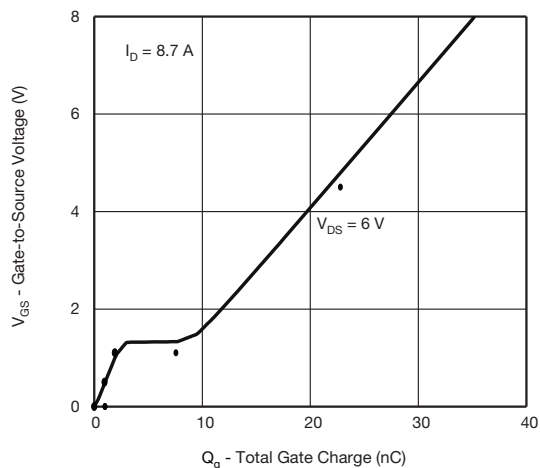
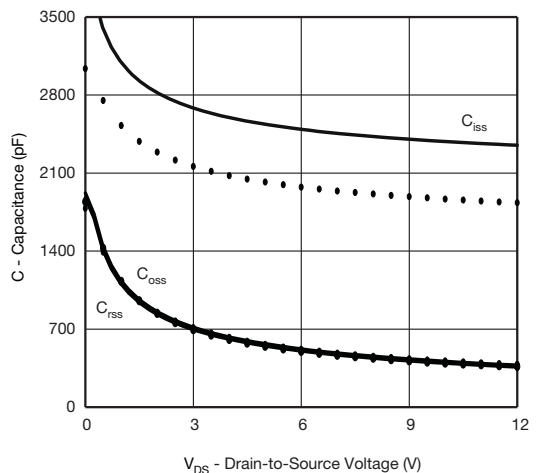
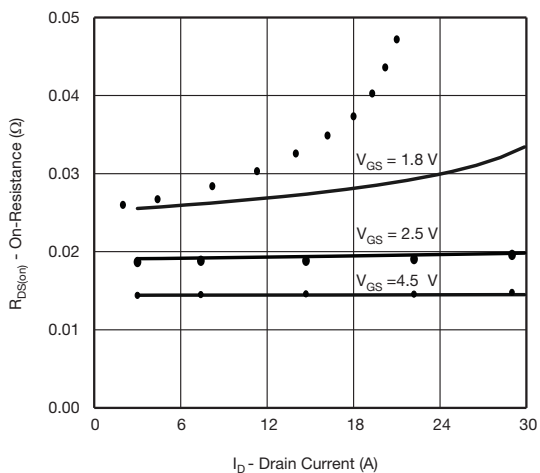
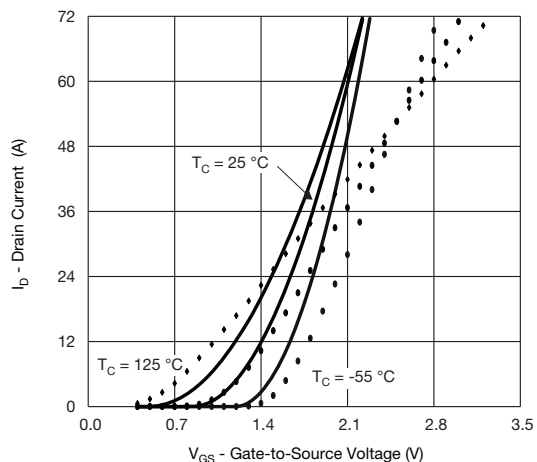
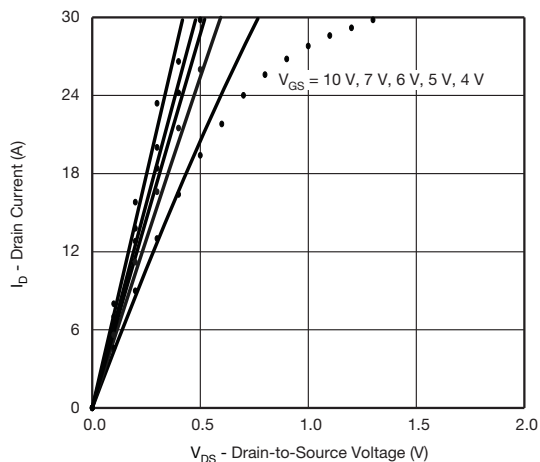
SPECIFICATIONS ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	SIMULATED DATA	MEASURED DATA	UNIT
Static					
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250\text{ }\mu\text{A}$	0.72	-	V
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}$, $I_D = -8.7\text{ A}$	0.0145	0.0145	Ω
		$V_{GS} = -2.5\text{ V}$, $I_D = -7.3\text{ A}$	0.0192	0.0198	
		$V_{GS} = -1.8\text{ V}$, $I_D = -2.6\text{ A}$	0.0260	0.0277	
Forward transconductance ^a	g_{fs}	$V_{DS} = -6\text{ V}$, $I_D = -8.7\text{ A}$	35	30	S
Diode forward voltage	V_{SD}	$I_S = -6.9\text{ A}$	-0.80	-0.80	V
Dynamic ^b					
Input capacitance	C_{iss}	$V_{DS} = -6\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$	2490	1975	pF
Output capacitance	C_{oss}		522	520	
Reverse transfer capacitance	C_{rss}		503	501	
Total gate charge	Q_g	$V_{DS} = -6\text{ V}$, $V_{GS} = -8\text{ V}$, $I_D = -8.7\text{ A}$	35.4	38	nC
			22	22.8	
Gate-source charge	Q_{gs}	$V_{DS} = -6\text{ V}$, $V_{GS} = -4.5\text{ V}$, $I_D = -8.7\text{ A}$	1.9	1.9	
Gate-drain charge	Q_{gd}		5.7	5.7	

Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing



COMPARISON OF MODEL WITH MEASURED DATA ($T_J = 25^\circ\text{C}$, unless otherwise noted)



Note

- Dots and squares represent measured data

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